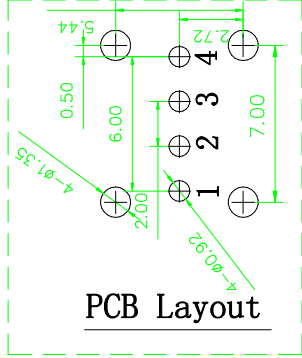
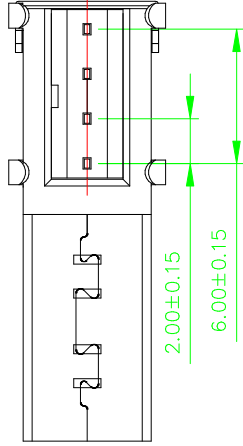
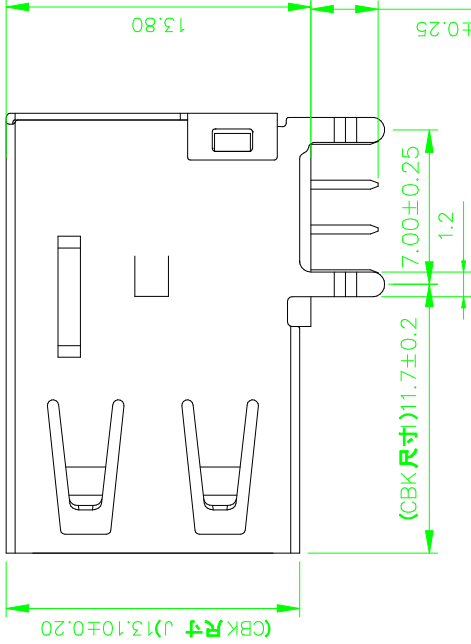
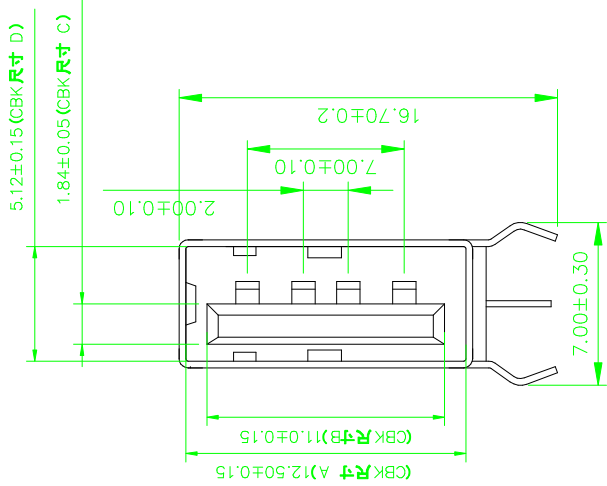
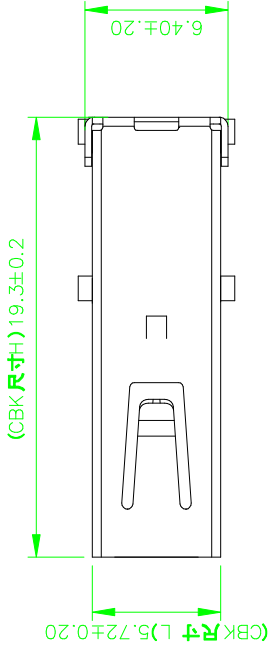




REV	ECN	DESCRIPTION	DATE	ECR
A		新版发行	2012/11/16	赵 振



SPECIFICATION:

Contact current Rating:

1 5 Amperes for pH1&pH4

Dielectric Withstanding Voltage: AC 500V(RMS)

Insulating resistance: 1000Megohms Minimum

Contact Resistance:

3-mΩ Max for pH1&pH4

Mechanical Characteristics:

Mating Force: 35 ~ 60mN Minimum

Withstanding Force: 10 ~ 20mN Minimum

MATERIAL:

Housing: PBT+30%GF 94V 0

Contact: copper alloy (T=0 25mm)

Shell: SPCC

PLATING:

Contact: Au Plated Contact area

TH Plated Solder area

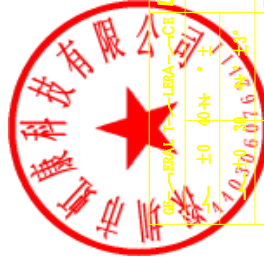
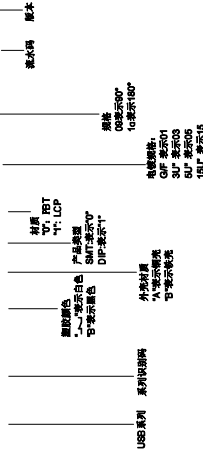
Nickel Underplating over all

Shell: Nickel Plated

Operating Temperature: 45° to +85°

盐雾8小时

U 2113-B 1 0 01 1a-26 A



DWG NO	DWG	DRAWING	赵 振	SCALE
2113-B 1 0 01 1a-26 A	USB AF 2.0 侧插连接器	CHECKED	赵 振	UNIT
TITLE	脚加塞 7.0 不带卷边	APPROVAL		mm
PART NO	SHK-20085	DATE	2017/3/27	

ITEM	CONTACT	4	BRASS	GOLD FLASH/μm 3μ/15μ T=0.25mm
②	HOUSING	1	PBT/LCP	BK/WH
①	SHELL	1	BRASS/SPCC	NICKEL PLATING T=0.30mm
ITEM	PART NAME	QTY/PCS	MATERIALS	NOTE

深圳市虹康科技有限公司